

# DS26LV31T 3V Enhanced CMOS Quad Differential Line Driver

### **General Description**

The DS26LV31T is a high-speed quad differential CMOS driver that meets the requirements of both TIA/EIA-422-B and ITU-T V.11. The CMOS DS26LV31T features low static I<sub>CC</sub> of 100  $\mu$ A MAX which makes it ideal for battery powered and power conscious applications.

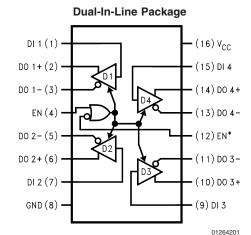
Differential outputs have the same  $V_{\rm OD}$  guarantee ( ${\geq}2V)$  as the 5V version.

The EN and EN\* inputs allow active Low or active High control of the TRI-STATE® outputs. The enables are common to all four drivers. Protection diodes protect all the driver inputs against electrostatic discharge. Outputs have enhanced ESD protection providing greater than 7 kV tolerance. The driver and enable inputs (DI, EN, EN\*) are compatible with low voltage LVTTL and LVCMOS devices.

#### Features

- Industrial product meets TIA/EIA-422-B (RS-422) and ITU-T V.11 recommendation
- Military product conforms to TIA/EIA-422-B (RS-422)

## **Connection Diagram**



Top View Order Number DS26LV31TM or DS26LV31W See NS Package Number M16A or W16A

#### Interoperable with existing 5V RS-422 networks

- Industrial and Military temperature range
- Guaranteed V<sub>OD</sub> of 2V min over operating conditions
- Balanced output crossover for low EMI (typical within 40 mV of 50% voltage level)
- Low power design (330 µW @ 3.3V static)
- ESD ≥ 7 kV on cable I/O pins (HBM)
- Guaranteed AC parameter:
  Maximum driver skew: 2 ns
  Maximum transition time: 10 ns
- Pin compatible with DS26C31
- Available in SOIC and Cerpack packaging
- Standard Microcircuit Drawing (SMD) 5962-98584

### **Truth Table**

Enables		Input	Outputs		
EN	EN*	DI	DO+	D0-	
L	Н	Х	Z	Z	
All other		L	L	Н	
combinations of enable inputs		н	Н	L	

L = Low logic state

X = Irrelevant

H = High logic stateZ = TRI-STATE DS26LV31T 3V Enhanced CMOS Quad Differential Line Driver

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# Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (V <sub>CC</sub> )	-0.5V to +7V
Enable Input Voltage (EN, EN*)	–0.5V to V $_{\rm CC}$ + 0.5V
Driver Input Voltage (DI)	–0.5V to $V_{\rm CC}$ + 0.5V
Clamp Diode Current	±20 mA
DC Output Current, per pin	±150 mA
Driver Output Voltage	
(Power Off: DO+, DO-)	-0.5V to +7V
Maximum Package Power Dissipate	on @+25°C
M Package	1226 mW
W Package	1119 mW
Derate M Package 9.8 mW/°C abov	/e +25°C
Derate W Package 7.5 mW/°C abov	ve +25°C
Storage Temperature Range	–65°C to +150°C

Lead Temperature Range	
Soldering	
(4 sec.)	+260°C
ESD Ratings (HBM, 1.5 kΩ,	
100 pF)	
Driver Outputs	≥7 kV
Other Pins	≥2.5 kV

# Recommended Operating Conditions

	Min	Тур	Мах	Units
Supply Voltage (V <sub>CC</sub> )	3.0	3.3	3.6	V
Operating Free Air Temp	erature	Range	(T <sub>A</sub> )	
DS26LV31T	-40	+25	+85	°C
DS26LV31W	-55	+25	+125	°C
Input Rise and Fall Time			500	ns

#### Electrical Characteristics(Note 2) (Note 3)

Symbol	Parameter	Cond	itions	Pin	Min	Тур	Мах	Units
V <sub>OD1</sub>	Output Differential Voltage	$R_{L} = \infty$ (No Load)		DO+,		3.3	4	V
V <sub>OD2</sub>	Output Differential Voltage	$R_{L} = 100\Omega$ (Figure	1)	DO-	2	2.6		V
$\Delta V_{OD2}$	Change in Magnitude of	I <sub>O</sub> ≥ 20 mA			-400	7	400	mV
	Output Differential Voltage							
V <sub>OD3</sub>	Output Differential Voltage	R <sub>L</sub> = 3900Ω (V.11)		] [		3.2	3.6	V
		Figure 1 (Note 7)						
V <sub>oc</sub>	Common Mode Voltage	$R_{L} = 100\Omega (Figure$	1)			1.5	2	V
$\Delta V_{OC}$	Change in Magnitude of				-400	6	400	mV
	Common Mode Voltage							
l <sub>oz</sub>	TRI-STATE Leakage	$V_{OUT} = V_{CC}$ or GND				±0.5	±20	μA
	Current	Drivers Disabled						
I <sub>SC</sub>	Output Short Circuit Currrent	V <sub>OUT</sub> = 0V	$T_A = -40^{\circ}C$ to	] [	-40	-70	-150	mA
	V <sub>IN</sub> = V <sub>CC</sub> or GND (Note 4)	$V_{IN} = V_{CC} \text{ or } +85^{\circ}\text{C}$	+85°C					
		GND (Note 4)	$T_A = -55^{\circ}C$ to		-30		-160	mA
			+125°C (Note 10)					
I <sub>OFF</sub>	Output Leakage Current	$V_{CC} = 0V, V_{OUT} = 3V \text{ or } 6V$				0.03	100	μA
	$V_{\rm CC} = 0V, V_{\rm OUT} =$				-0.08	-100	μA	
		–0.25V	+85°C					
			$T_A = -55^{\circ}C$ to				-200	μA
			+125°C					
V <sub>IH</sub>	High Level Input Voltage			DI,	2.0		V <sub>CC</sub>	V
V <sub>IL</sub>	Low Level Input Voltage			EN,	GND		0.8	V
I <sub>IH</sub>	High Level Input Current	$V_{IN} = V_{CC}$		EN*			10	μA
I <sub>IL</sub>	Low Level Input Current	V <sub>IN</sub> = GND	V <sub>IN</sub> = GND		-10			μA
V <sub>CL</sub>	Input Clamp Voltage	I <sub>IN</sub> = -18 mA					-1.5	V
I <sub>cc</sub>	Power Supply Current	No Load, $V_{IN}$ (all) = $V_{CC}$ or GND	T <sub>A</sub> = -40°C to +85°C	V <sub>cc</sub>			100	μA
			T <sub>A</sub> = -55°C to +125°C				125	μA

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# Switching Characteristics - Industrial (Note 5) (Note 6)

Over supply voltage and -40°C to +85°C operating temperature range, unless otherwise specified

Sym	Parameter	Conditions	Min	Тур	Мах	Units
t <sub>PHLD</sub>	Differential Propagation Delay	$R_{L} = 100\Omega, C_{L} = 50 \text{ pF}$	6	10.5	16	ns
	High to Low	( <i>Figures 2, 3</i> )				
t <sub>PLHD</sub>	Differential Propagation Delay		6	11	16	ns
	Low to High					
t <sub>skD</sub>	Differential Skew (same			0.5	2.0	ns
	channel) It <sub>PHLD</sub> – t <sub>PLHD</sub> I					
t <sub>sĸ1</sub>	Skew, Pin to Pin			1.0	2.0	ns
	(same device)					
t <sub>SK2</sub>	Skew, Part to Part (Note 8)			3.0	5.0	ns
t <sub>TLH</sub>	Differential Transition Time			4.2	10	ns
	Low to High (20% to 80%)					
t <sub>THL</sub>	Differential Transition Time			4.7	10	ns
	High to Low (80% to 20%)					
t <sub>PHZ</sub>	Disable Time High to Z	(Figures 4, 5)		12	20	ns
t <sub>PLZ</sub>	Disable Time Low to Z			9	20	ns
t <sub>PZH</sub>	Enable Time Z to High			22	32	ns
t <sub>PZL</sub>	Enable Time Z to Low			22	32	ns
f <sub>max</sub>	Maximum Operating		32			MHz
	Frequency (Note 9)					

#### Switching Characteristics - Military (Note 5) (Note 6)

Over supply voltage and -55°C to +125°C operating temperature range, unless otherwise specified

Sym	Parameter	Conditions	Min	Max	Units
t <sub>PHLD</sub>	Differential Propagation Delay	$R_{L} = 100\Omega, C_{L} = 50 \text{ pF}$	5	25	ns
	High to Low	( <i>Figures 2, 3</i> )			
t <sub>PLHD</sub>	Differential Propagation Delay		5	25	ns
	Low to High				
t <sub>skD</sub>	Differential Skew (same			5.0	ns
	channel)  t <sub>PHLD</sub> - t <sub>PLHD</sub>				
t <sub>SK1</sub>	Skew, Pin to Pin			5.0	ns
	(same device)				
t <sub>PHZ</sub>	Disable Time High to Z	(Figures 4, 5)		35	ns
t <sub>PLZ</sub>	Disable Time Low to Z			35	ns
t <sub>PZH</sub>	Enable Time Z to High			40	ns
t <sub>PZL</sub>	Enable Time Z to Low			40	ns

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" specifies conditions of device operation.

Note 2: Current into device pins is defined as positive. Current out of device pins is defined as negative. All voltages are referenced to ground except differential voltages V<sub>OD1</sub>, V<sub>OD2</sub>, V<sub>OD3</sub>.

**Note 3:** All typicals are given for  $V_{CC} = +3.3V$ ,  $T_A = +25^{\circ}C$ .

Note 4: Only one output shorted at a time. The output (true or complement) is configured High.

Note 5: f = 1 MHz,  $t_r$  and  $t_f \le 6$  ns, 10% to 90%.

Note 6: See TIA/EIA-422-B specifications for exact test conditions.

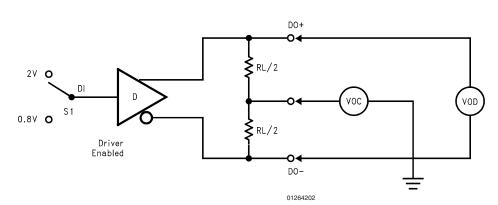
Note 7: This specification limit is for compliance with TIA/EIA-422-B and ITU-T V.11.

Note 8: Devices are at the same  $V_{CC}$  and within 5°C within the operating temperature range

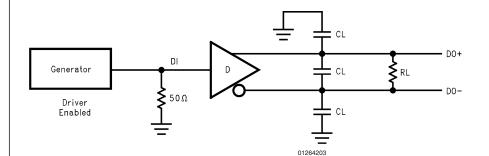
Note 9: All channels switching, output duty cycle criteria is 40%/60% measured at 50%. This parameter is guaranteed by design and characterization.

Note 10: This parameter does not meet the TIA/EIA-422-B specification.

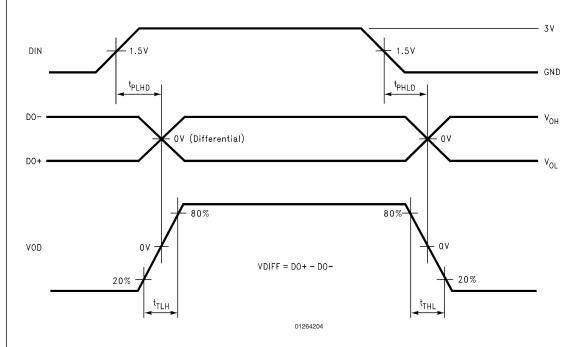
#### **Parameter Measurement Information**



#### FIGURE 1. Differential Driver DC Test Circuit

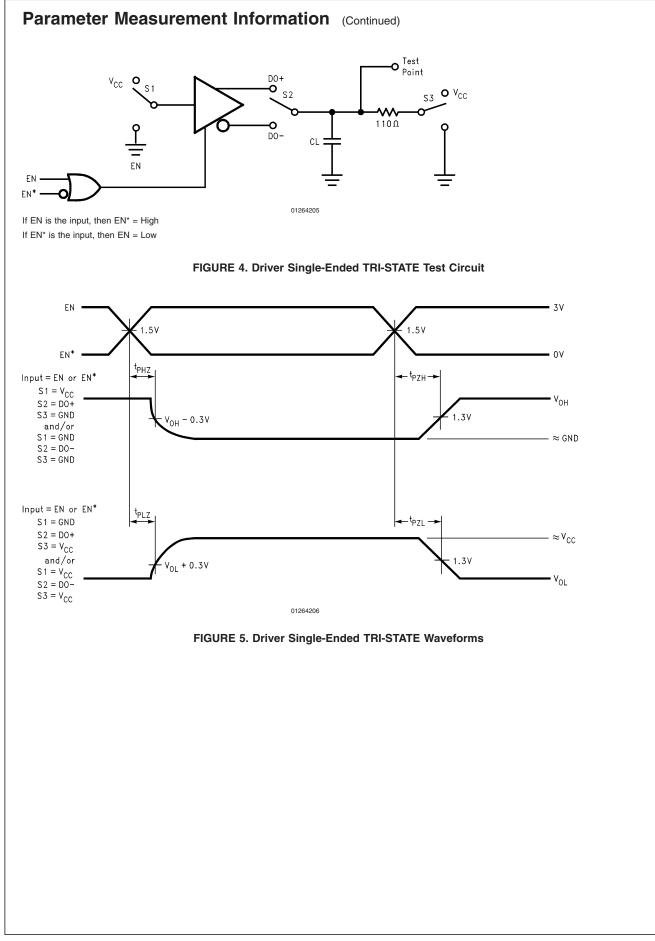


#### FIGURE 2. Differential Driver Propagation Delay and Transition Time Test Circuit



#### FIGURE 3. Differential Driver Propagation Delay and Transition Time Waveforms

Note 11: Generator waveform for all tests unless otherwise specified: f = 1 MHz, Duty Cycle = 50% Z<sub>o</sub> = 50 $\Omega$ ,  $t_r \le 10$  ns,  $t_f \le 10$ . Note 12: C<sub>L</sub> includes probe and fixture capacitance.



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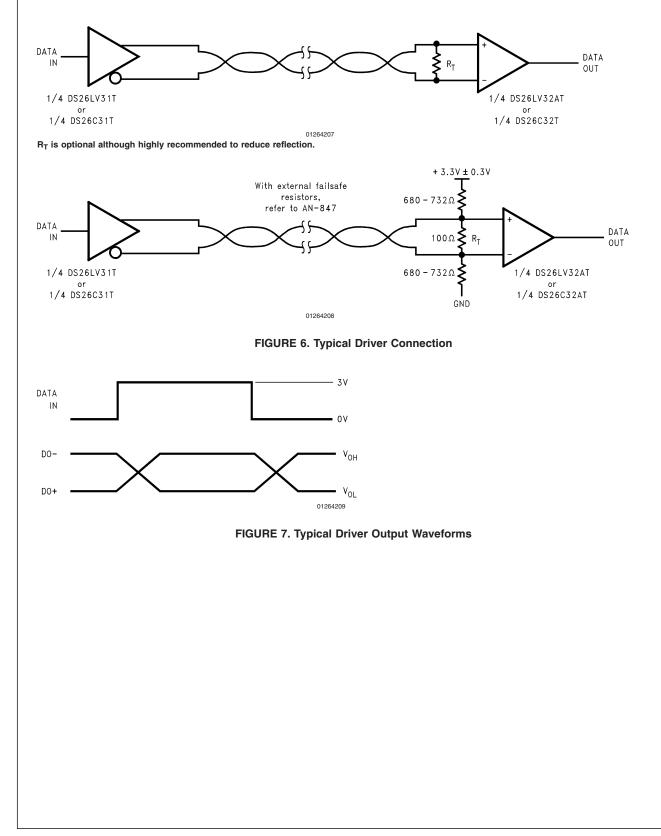
#### **Typical Application Information**

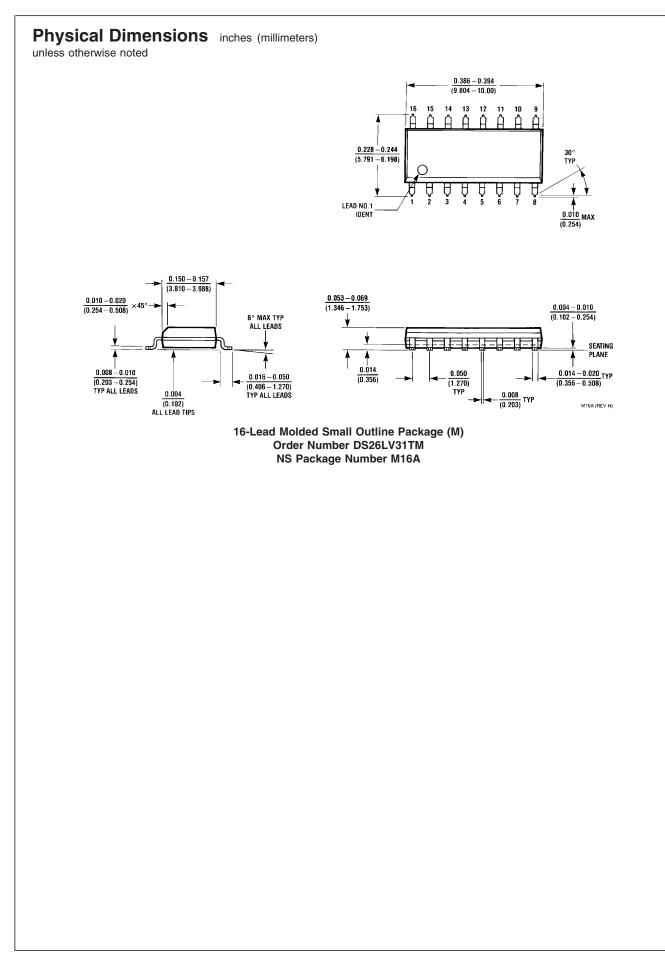
General application guidelines and hints for differential drivers and receivers may be found in the following application notes:

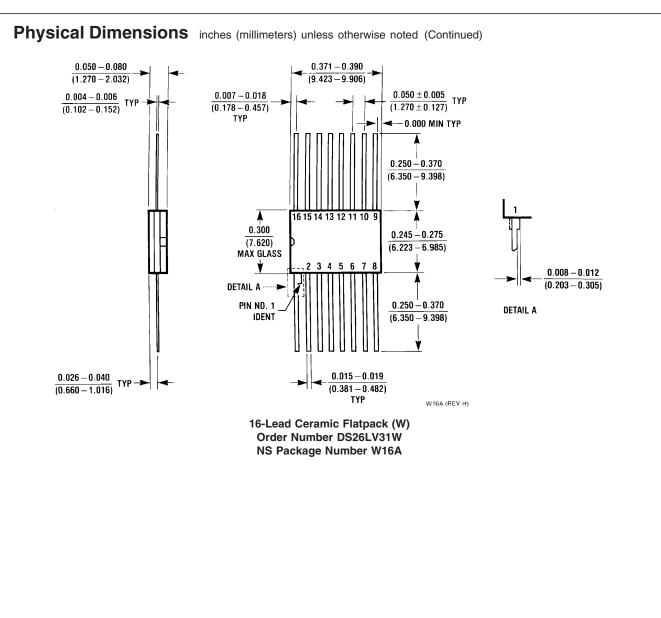
AN-214, AN-457, AN-805, AN-847, AN-903, AN-912, AN-

Power Decoupling Recommendations:

Bypass caps must be used on power pins. High frequency ceramic (surface mount is recommended) 0.1  $\mu F$  in parallel with 0.01  $\mu F$  at the power supply pin. A 10  $\mu F$  or greater solid tantalum or electrolytic should be connected at the power entry point on the printed circuit board.







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